

## Absolute Maximum Ratings

Symbol	Conditions <sup>1)</sup>	Values		Units
		... 101 D	... 121 D	
V <sub>CES</sub>		1000	1200	V
V <sub>CGR</sub>	R <sub>GE</sub> = 20 kΩ	1000	1200	V
I <sub>C</sub>	T <sub>case</sub> = 25/80 °C	150/100		A
I <sub>CM</sub>	T <sub>case</sub> = 25/80 °C	300/200		A
V <sub>GES</sub>		± 20		V
P <sub>tot</sub>	per IGBT, T <sub>case</sub> = 25 °C	1000		W
T <sub>J</sub> , T <sub>stg</sub>		- 55 ... +150		°C
V <sub>isol</sub>	AC, 1 min	2 500		V
humidity	DIN 40 040	Class F		
climate	DIN IEC 68 T.1	55/150/56		
Inverse Diode				
I <sub>F</sub> = - I <sub>C</sub>		150		A
I <sub>FM</sub> = - I <sub>CM</sub>		300		A

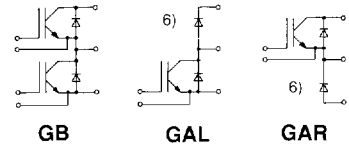
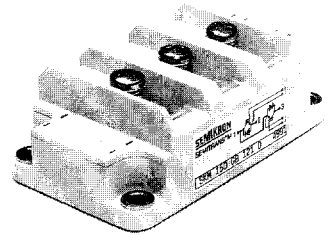
## Characteristics

Symbol	Conditions <sup>1)</sup>	min. typ. max.			Units
		V <sub>(BR)CES</sub>	V <sub>GE</sub> = 0, I <sub>C</sub> = 2 mA	≥ V <sub>CES</sub>	
V <sub>GE(th)</sub>	V <sub>GE</sub> = V <sub>CE</sub> , I <sub>C</sub> = 8 mA	4,5	5,5	6,5	V
I <sub>CES</sub>	V <sub>GE</sub> = 0	-	-	2	mA
I <sub>GES</sub>	V <sub>GE</sub> = 20 V, V <sub>CE</sub> = 0	-	-	100	nA
V <sub>CEsat</sub>	V <sub>GE</sub> = 15 V	-	3,5	4	V
	I <sub>C</sub> = 150 A	-	4	5	V
g <sub>is</sub>	V <sub>CE</sub> = 20 V, I <sub>C</sub> = 150 A	44	64	-	S
C <sub>CHC</sub>	per IGBT	-	-	200	pF
C <sub>ies</sub>	V <sub>GE</sub> = 0	-	16	-	nF
C <sub>oes</sub>	V <sub>CE</sub> = 25 V	-	1300	-	pF
C <sub>res</sub>	f = 1 MHz	-	500	-	pF
L <sub>CE</sub>		-	-	80	nH
t <sub>d(on)</sub>	V <sub>CC</sub> = 600 V	-	150 <sup>3)</sup>	-	ns
t <sub>r</sub>	V <sub>GE</sub> = 15 V	-	350 <sup>3)</sup>	-	ns
t <sub>d(off)</sub>	I <sub>C</sub> = 150 A	-	700 <sup>3)</sup> /700 <sup>4)</sup>	-	ns
t <sub>f</sub>	R <sub>Gon</sub> = R <sub>Goff</sub> = 3,3 Ω	-	450 <sup>3)</sup> /100 <sup>4)</sup>	-	ns
W <sub>off12</sub> <sup>5)</sup>	T <sub>J</sub> = 125 °C	-	15 <sup>4)</sup>	-	mWs
W <sub>off23</sub> <sup>5)</sup>		-	8 <sup>4)</sup>	-	mWs
Inverse Diode ...101 D, ...102 D					
V <sub>F</sub> = V <sub>EC</sub>	I <sub>F</sub> = 150 A, V <sub>GE</sub> = 0; (T <sub>J</sub> = 125 °C)	-	2,1 (1,9)	2,8	V
t <sub>rr</sub>	T <sub>J</sub> = 25 °C <sup>2)</sup>	-	-	-	ns
	T <sub>J</sub> = 125 °C <sup>2)</sup>	-	300	-	ns
Q <sub>rr</sub>	T <sub>J</sub> = 25/125 °C <sup>2)</sup>	-	4/18	-	μC
f <sub>s</sub>	f <sub>s</sub> = t <sub>r</sub> / (t <sub>rr</sub> - t <sub>r</sub> )	-	1 <sup>2)</sup>	-	
Inverse Diode ...121 D, ...122 D					
V <sub>F</sub> = V <sub>EC</sub>	I <sub>F</sub> = 150 A, V <sub>GE</sub> = 0; (T <sub>J</sub> = 125 °C)	-	2,7 (2,1)	3,2	V
t <sub>rr</sub>	T <sub>J</sub> = 25 °C <sup>2)</sup>	-	-	-	ns
	T <sub>J</sub> = 125 °C <sup>2)</sup>	-	350	-	ns
Q <sub>rr</sub>	T <sub>J</sub> = 25/125 °C <sup>2)</sup>	-	5/20	-	μC
f <sub>s</sub>	f <sub>s</sub> = t <sub>r</sub> / (t <sub>rr</sub> - t <sub>r</sub> )	-	1 <sup>2)</sup>	-	
Thermal Characteristics					
R <sub>thjc</sub>	per IGBT	-	-	0,13	°C/W
R <sub>thjc</sub>	per diode	-	-	0,5	°C/W
R <sub>thch</sub>	per module	-	-	0,038	°C/W

Cases and mechanical data see page B 6 – 126

## SEMITRANS® M IGBT Modules

SKM 150 GB 101 D, 102 D  
 SKM 150 GAL 101D, 102 D <sup>6)</sup>  
 SKM 150 GAR 101 D <sup>6)</sup>  
 SKM 150 GB 121 D, 122 D  
 SKM 150 GAL 121 D, 122 D <sup>6)</sup>  
 SKM 150 GAR 121 D, 122 D <sup>6)</sup>



### Features

- MOS input (voltage controlled)
- N channel
- Low saturation voltage
- Very low tail current
- Low temperature sensitivity
- High short circuit capability
- No latch-up
- Fast inverse diodes
- Isolated copper baseplate
- Large clearances and creepage distances
- UL recognized, file no. E 63 532

### Typical Applications

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<sup>1)</sup> T<sub>case</sub> = 25 °C, unless otherwise specified

<sup>2)</sup> I<sub>F</sub> = - I<sub>C</sub>, V<sub>R</sub> = 600 V, - di<sub>F</sub>/dt = 800 A/μs, V<sub>GE</sub> = 0

<sup>3)</sup> resistive load

<sup>4)</sup> inductive load

<sup>5)</sup> see fig. 21; R<sub>Goff</sub> = 4 Ω

<sup>6)</sup> The free-wheeling diodes of the GAL and GAR types have the data of the inverse diodes of SKM 200 ...

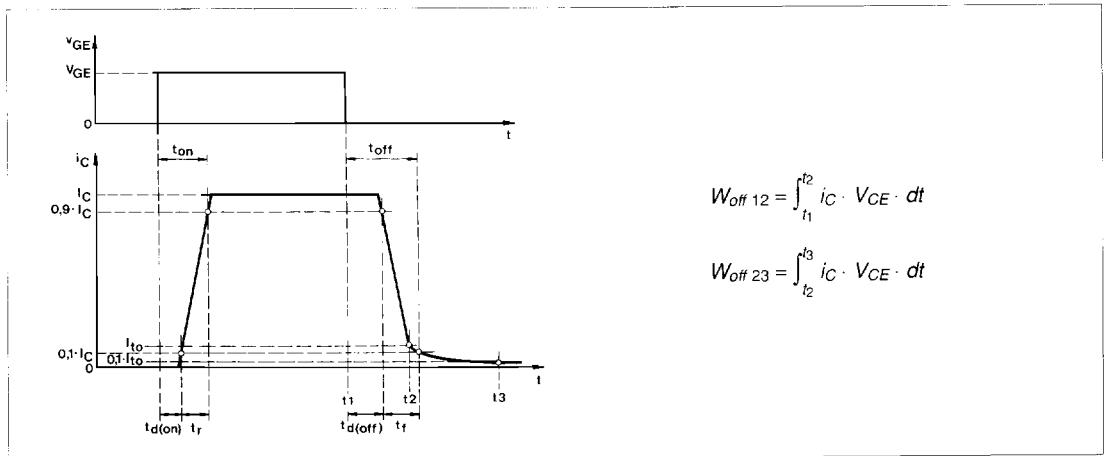


Fig. 21 Switching times and turn-off energies

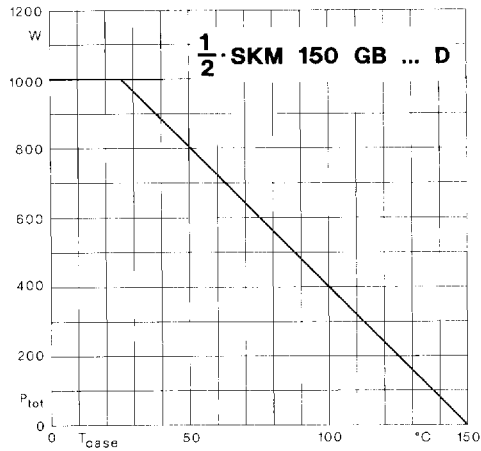


Fig. 22 Rated power dissipation vs. temperature

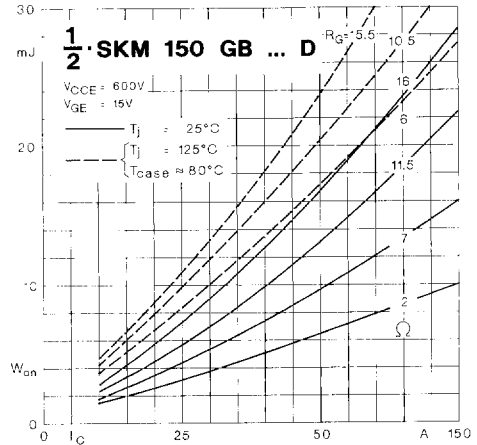


Fig. 23 Turn-on energy dissipation per pulse

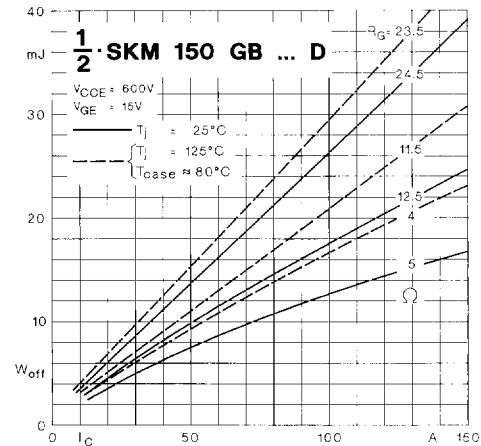


Fig. 24 Turn-off energy dissipation per pulse

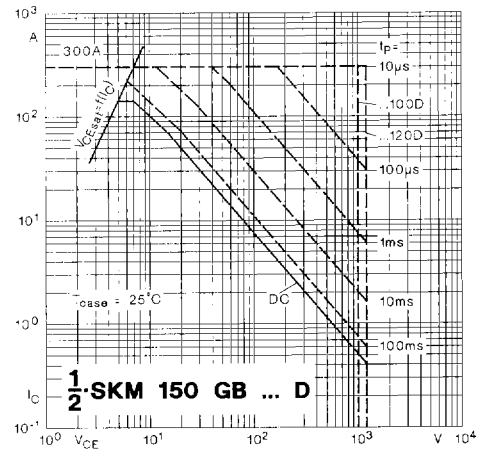


Fig. 25 Maximum safe operating area

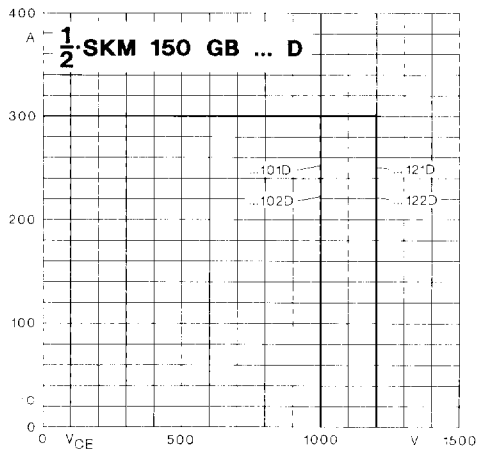


Fig. 26 Turn-off safe operating area

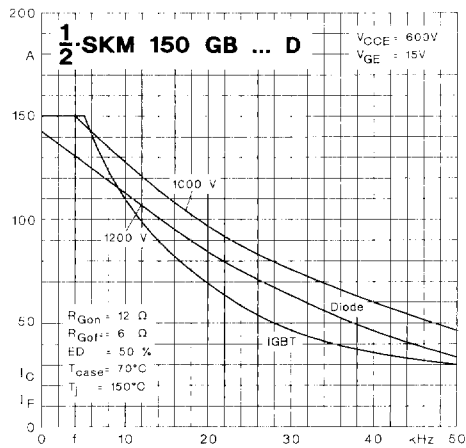


Fig. 27 Rated current vs. pulse frequency

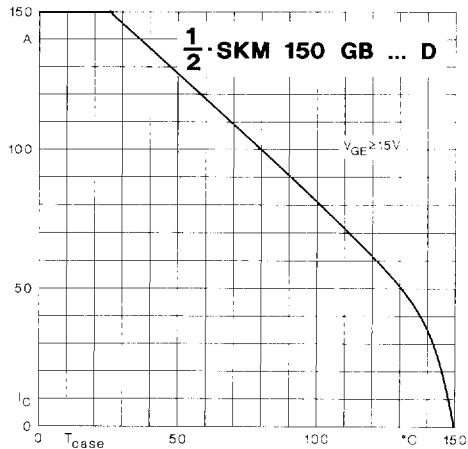


Fig. 28 Rated current vs. temperature

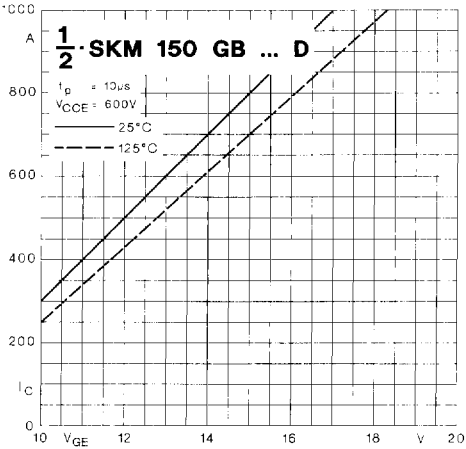


Fig. 29 Short-circuit current vs. turn-on gate voltage

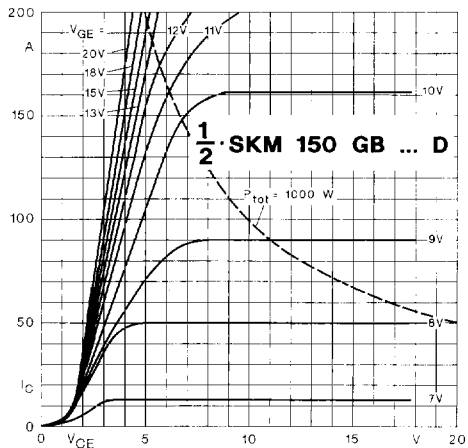


Fig. 30 Output characteristic

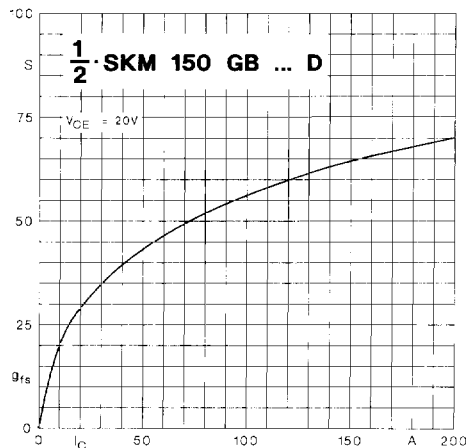


Fig. 31 Forward transconductance

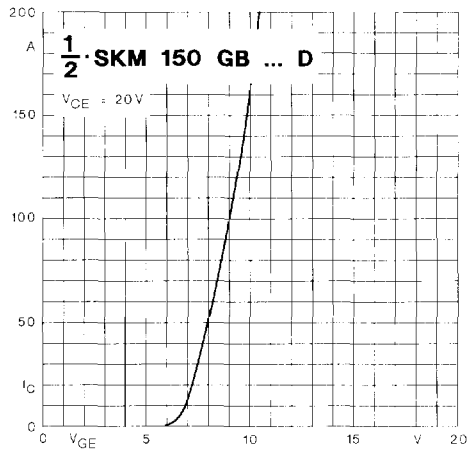


Fig. 32 Transfer characteristic

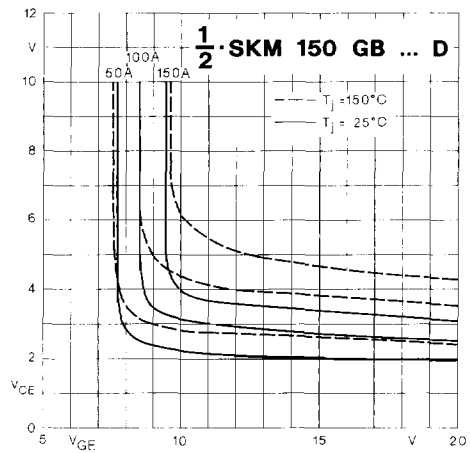


Fig. 33 Saturation characteristics

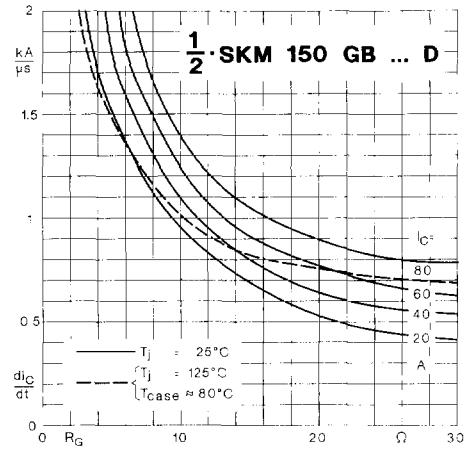


Fig. 34 Rate of rise of collector current

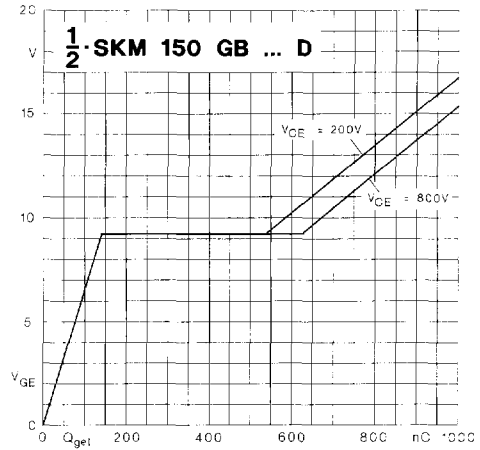


Fig. 35 Gate charge characteristic

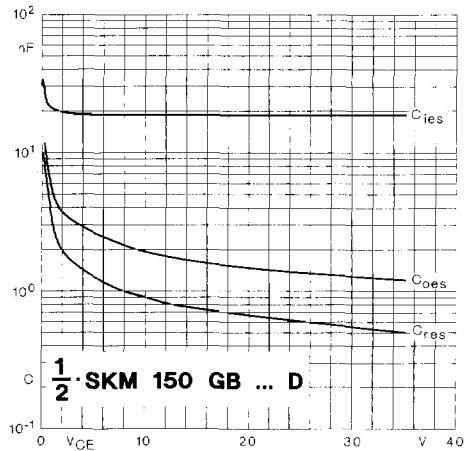


Fig. 36 Capacitances vs. collector-emitter voltage

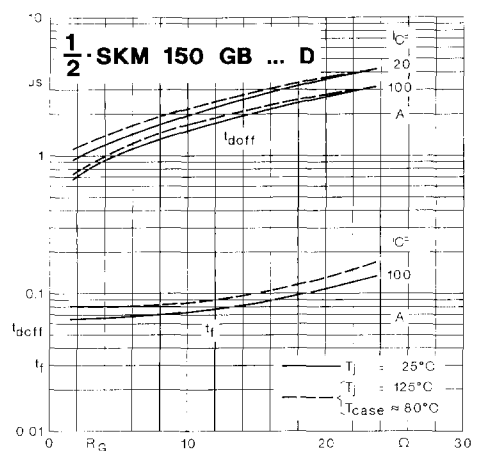


Fig. 37 Switching times vs. gate resistor

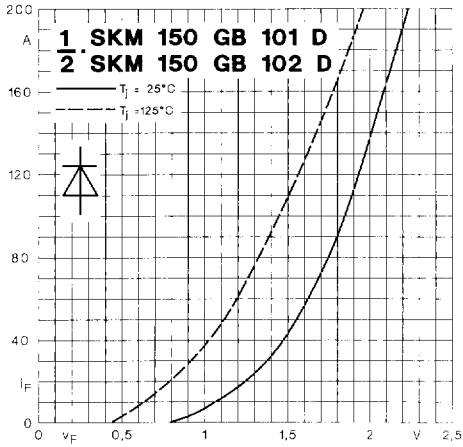


Fig. 38 a Diode forward characteristic

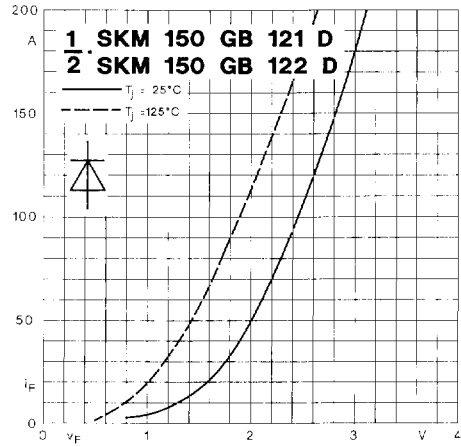


Fig. 38 b Diode forward characteristic

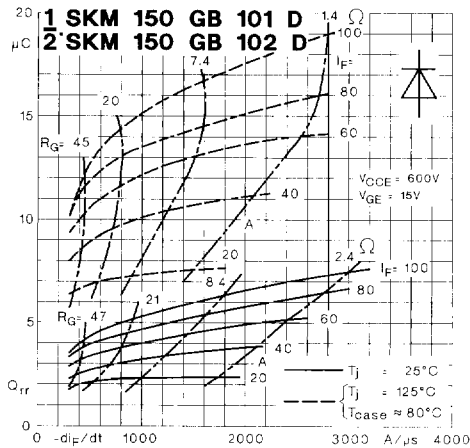


Fig. 39 a Diode recovered charge

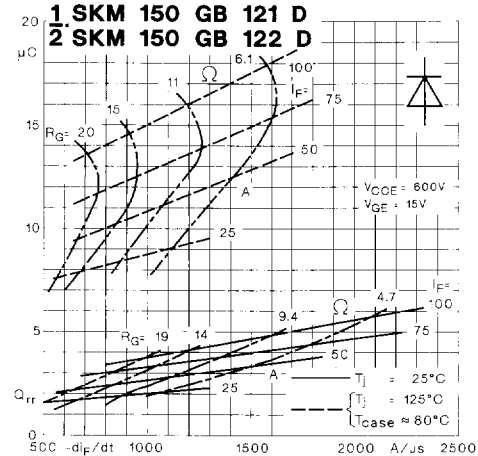


Fig. 39 b Diode recovered charge

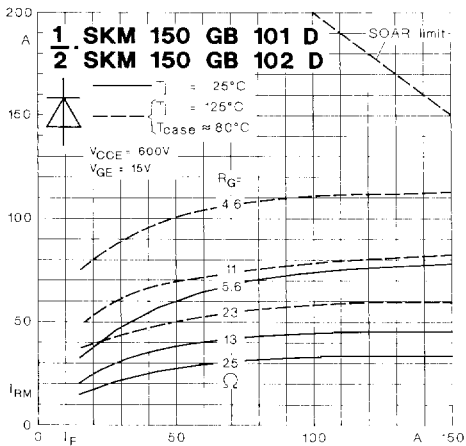


Fig. 40 a Diode peak reverse recovery current ( $I_{\text{RM}}$ )

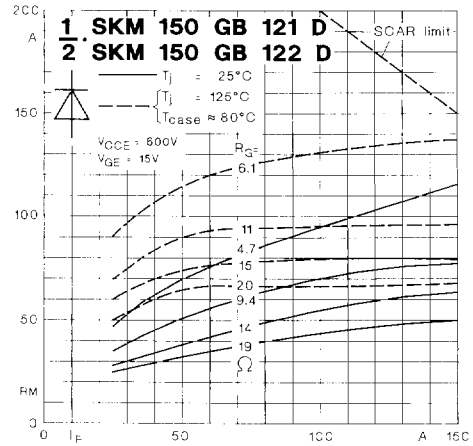


Fig. 40 b Diode peak reverse recovery current ( $I_{\text{RM}}$ )

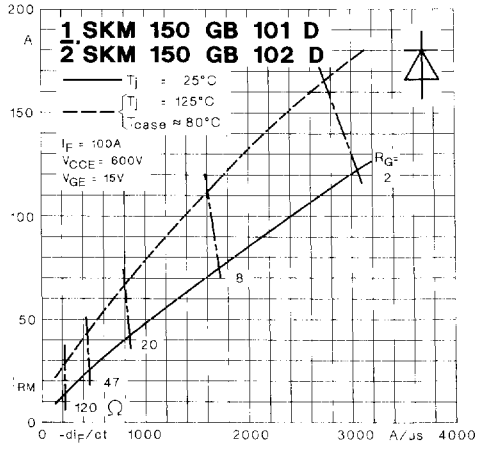


Fig. 41 a Diode peak reverse recovery current ( $-di_F/dt$ )

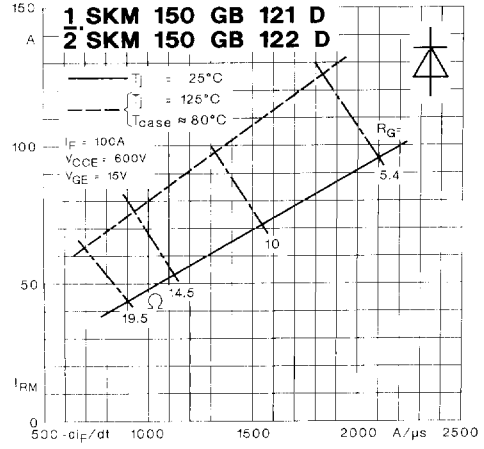


Fig. 41 b Diode peak reverse recovery current ( $-di_F/dt$ )

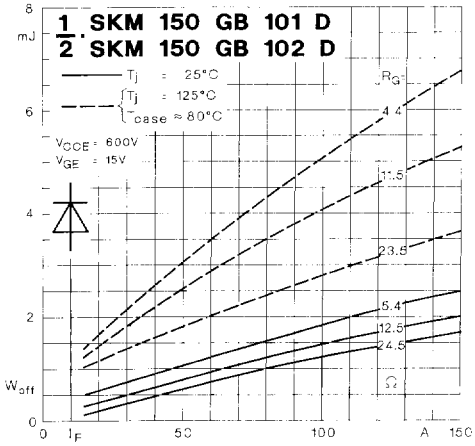


Fig. 42 a Diode turn-off energy dissipation per pulse

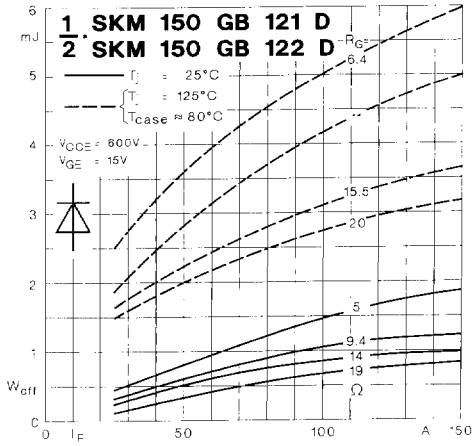


Fig. 42 b Diode turn-off energy dissipation per pulse

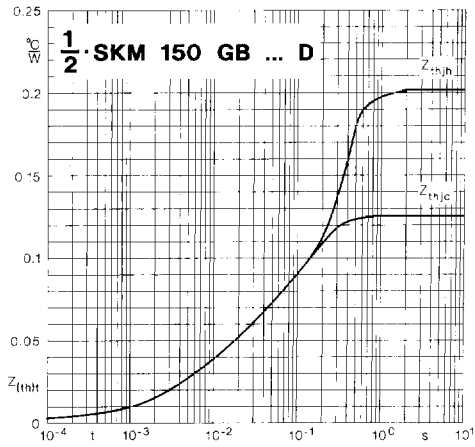


Fig. 51 Transient thermal impedance

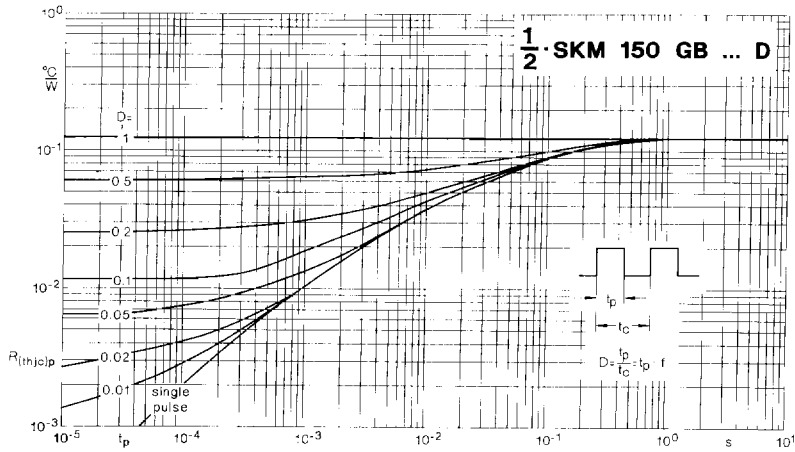


Fig. 52 Thermal impedance under pulse conditions

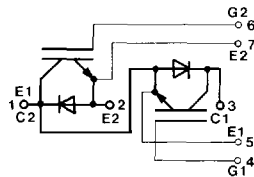
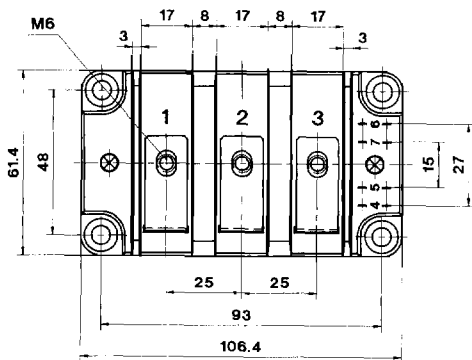
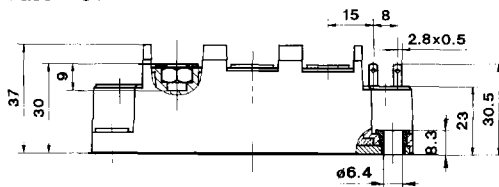
SKM 150 GB 101 D

SKM 150 GB 121 D

Case D 31

UL recognized,

file no. E 63 532



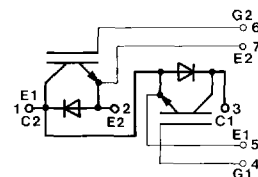
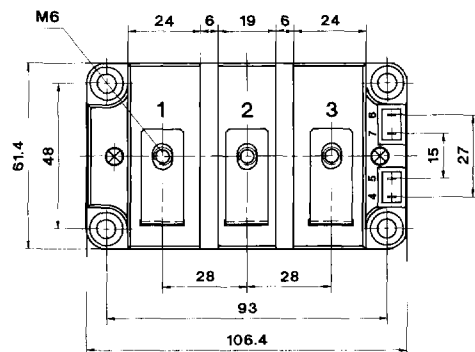
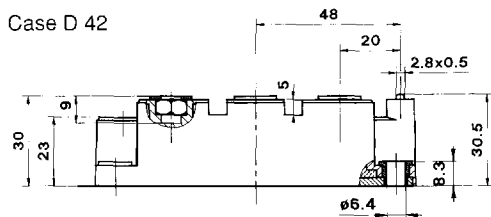
SKM 150 GB 102 D

SKM 150 GB 122 D

Case D 42

UL recognized,

file no. E 63 532



SKM 150 GAL 101 D

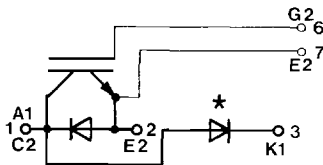
SKM 150 GAL 121 D

Case D 35 (→ D 31)

SKM 150 GAL 102 D

SKM 150 GAL 122 D

Case D 43 (→ D 42)



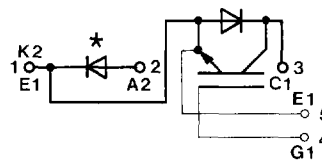
SKM 150 GAR 101 D

SKM 150 GAR 121 D

Case D 36 (→ D 31)

SKM 150 GAR 122 D

Case D 44 (→ D 42)



### Mechanical Data

Symbol	Conditions	Values			Units
		min.	typ.	max.	
M <sub>1</sub>	to heatsink, SI Units	3	—	6	Nm
	to heatsink, US Units	27	—	53	lb.in.
M <sub>2</sub>	for terminals, SI Units	2,5	—	5	Nm
	for terminals US Units	22	—	44	lb.in.
a		—	—	5x9,81	m/s <sup>2</sup>
w		—	—	420	g

This is an electrostatic discharge sensitive device (ESDS). Please observe the international standard IEC 747-1, Chapter IX.

★The free-wheeling diode has the data of the inverse diode of SKM 200 ...

Dimensions in mm